

### ADG511/ADG512/ADG513

#### FEATURES

**+3 V, +5 V or  $\pm 5$  V Power Supplies**  
**Ultralow Power Dissipation ( $<0.5 \mu\text{W}$ )**  
**Low Leakage ( $<100 \text{ pA}$ )**  
**Low On Resistance ( $<50 \Omega$ )**  
**Fast Switching Times**  
**Low Charge Injection**  
**TTL/CMOS Compatible**  
**16-Lead DIP or SOIC Package**

#### APPLICATIONS

**Battery-Powered Instruments**  
**Single Supply Systems**  
**Remote Powered Equipment**  
**5 V Supply Systems**  
**Computer Peripherals such as Disk Drives**  
**Precision Instrumentation**  
**Audio and Video Switching**  
**Automatic Test Equipment**  
**Precision Data Acquisition**  
**Sample Hold Systems**  
**Communication Systems**  
**Compatible with  $\pm 5$  V Supply DACs and ADCs such as**  
**AD7840/AD7848, AD7870/AD7871/AD7872/AD7874/**  
**AD7875/AD7876/AD7878**

#### GENERAL DESCRIPTION

The ADG511, ADG512 and ADG513 are monolithic CMOS ICs containing four independently selectable analog switches. These switches feature low, well-controlled on resistance and wide analog signal range, making them ideal for precision analog signal switching.

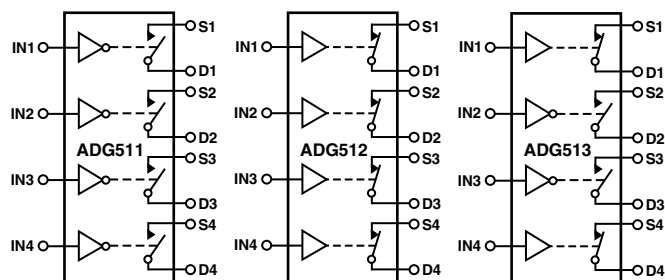
These switch arrays are fabricated using Analog Devices' advanced linear compatible CMOS (LC<sup>2</sup>MOS) process which offers the additional benefits of low leakage currents, ultralow power dissipation and low capacitance for fast switching speeds with minimum charge injection. These features make the ADG511, ADG512 and ADG513 the optimum choice for a wide variety of signal switching tasks in precision analog signal processing and data acquisition systems.

The ability to operate from single +3 V, +5 V or  $\pm 5$  V bipolar supplies make the ADG511, ADG512 and ADG513 perfect for use in battery-operated instruments, 4–20 mA loop systems and with the new generation of DACs and ADCs from Analog Devices. The use of 5 V supplies and reduced operating currents give much lower power dissipation than devices operating from  $\pm 15$  V supplies.

#### REV. C

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#### FUNCTIONAL BLOCK DIAGRAMS



SWITCHES SHOWN FOR A LOGIC "1" INPUT

The ADG511, ADG512 and ADG513 contain four independent SPST switches. The ADG511 and ADG512 differ in that the digital control logic is inverted. The ADG511 switch is turned on with a logic low on the appropriate control input, while a logic high is required for the ADG512. The ADG513 contains two switches whose digital control logic is similar to that of the ADG511 while the logic is inverted in the remaining two switches.

#### PRODUCT HIGHLIGHTS

- 5 Volt Single Supply Operation**  
 The ADG511/ADG512/ADG513 offers high performance, including low on resistance and wide signal range, fully specified and guaranteed with +3 V,  $\pm 5$  V as well as +5 V supply rails.
- Ultralow Power Dissipation**  
 CMOS construction ensures ultralow power dissipation.
- Low  $R_{ON}$**
- Break-Before-Make Switching**  
 Switches are guaranteed to have break-before-make operation. This allows multiple outputs to be tied together for multiplexer applications without the possibility of momentary shorting between channels.

# ADG511/ADG512/ADG513—SPECIFICATIONS<sup>1</sup>

Dual Supply ( $V_{DD} = +5\text{ V} \pm 10\%$ ,  $V_{SS} = -5\text{ V} \pm 10\%$ ,  $GND = 0\text{ V}$ , unless otherwise noted)

Parameter	B Versions		T Version		Unit	Test Conditions/Comments
	25°C	-40°C to +85°C	25°C	-55°C to +125°C		
<b>ANALOG SWITCH</b> Analog Signal Range $R_{ON}$	30	$V_{DD}$ to $V_{SS}$ 50	30	$V_{DD}$ to $V_{SS}$ 50	V $\Omega$ typ $\Omega$ max	$V_D = \pm 3.5\text{ V}$ , $I_S = -10\text{ mA}$ ; $V_{DD} = +4.5\text{ V}$ , $V_{SS} = -4.5\text{ V}$
<b>LEAKAGE CURRENTS</b> Source OFF Leakage $I_S$ (OFF) Drain OFF Leakage $I_D$ (OFF) Channel ON Leakage $I_D$ , $I_S$ (ON)	$\pm 0.025$ $\pm 0.1$ $\pm 0.025$ $\pm 0.1$ $\pm 0.05$ $\pm 0.2$	$\pm 2.5$ $\pm 2.5$ $\pm 5$	$\pm 0.025$ $\pm 0.1$ $\pm 0.025$ $\pm 0.1$ $\pm 0.05$ $\pm 0.2$	$\pm 2.5$ $\pm 2.5$ $\pm 5$	nA typ nA max nA typ nA max nA typ nA max	$V_{DD} = +5.5\text{ V}$ , $V_{SS} = -5.5\text{ V}$ $V_D = \pm 4.5\text{ V}$ , $V_S = \mp 4.5\text{ V}$ ; Test Circuit 2 $V_D = \pm 4.5\text{ V}$ , $V_S = \mp 4.5\text{ V}$ ; Test Circuit 2 $V_D = V_S = \pm 4.5\text{ V}$ ; Test Circuit 3
<b>DIGITAL INPUTS</b> Input High Voltage, $V_{INH}$ Input Low Voltage, $V_{INL}$ Input Current $I_{INL}$ or $I_{INH}$		2.4 0.8 $\pm 0.1$		2.4 0.8 $\pm 0.1$	V min V max $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{IN} = V_{INL}$ or $V_{INH}$
<b>DYNAMIC CHARACTERISTICS<sup>2</sup></b> $t_{ON}$ $t_{OFF}$ Break-Before-Make Time Delay, $t_D$ (ADG513 Only) Charge Injection OFF Isolation Channel-to-Channel Crosstalk $C_S$ (OFF) $C_D$ (OFF) $C_D$ , $C_S$ (ON)	200 120 100 11 68 85 9 9 35	375 150	200 120 100 11 68 85 9 9 35	375 150	ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ	$R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_S = \pm 3\text{ V}$ ; Test Circuit 4 $R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_S = \pm 3\text{ V}$ ; Test Circuit 4 $R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_{S1} = V_{S2} = 3\text{ V}$ ; Test Circuit 5 Test Circuit 6 $R_L = 50\ \Omega$ , $C_L = 5\text{ pF}$ , $f = 1\text{ MHz}$ ; Test Circuit 7 $R_L = 50\ \Omega$ , $C_L = 5\text{ pF}$ , $f = 1\text{ MHz}$ ; Test Circuit 8 $f = 1\text{ MHz}$ $f = 1\text{ MHz}$ $f = 1\text{ MHz}$
<b>POWER REQUIREMENTS</b> $V_{DD}$ $V_{SS}$ $I_{DD}$ $I_{SS}$		+4.5/5.5 -4.5/-5.5 1 1		+4.5/5.5 -4.5/-5.5 1 1	V min/max V min/max $\mu\text{A}$ typ $\mu\text{A}$ max $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{DD} = +5.5\text{ V}$ , $V_{SS} = -5.5\text{ V}$ Digital Inputs = 0 V or 5 V

## NOTES

<sup>1</sup>Temperature ranges are as follows: B Versions -40°C to +85°C; T Version -55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

## Single Supply ( $V_{DD} = 5\text{ V} \pm 10\%$ , $V_{SS} = 0\text{ V}$ , $GND = 0\text{ V}$ , unless otherwise noted)

Parameter	B Versions		T Version		Unit	Test Conditions/Comments
	25°C	-40°C to +85°C	25°C	-55°C to +125°C		
<b>ANALOG SWITCH</b> Analog Signal Range $R_{ON}$	45	0 V to $V_{DD}$ 75	45	0 V to $V_{DD}$ 75	V $\Omega$ typ $\Omega$ max	$V_D = 3.5\text{ V}$ , $I_S = -10\text{ mA}$ ; $V_{DD} = 4.5\text{ V}$
<b>LEAKAGE CURRENTS</b> Source OFF Leakage $I_S$ (OFF) Drain OFF Leakage $I_D$ (OFF) Channel ON Leakage $I_D$ , $I_S$ (ON)	$\pm 0.025$ $\pm 0.1$ $\pm 0.025$ $\pm 0.1$ $\pm 0.05$ $\pm 0.2$	$\pm 2.5$ $\pm 2.5$ $\pm 2.5$ $\pm 5$	$\pm 0.025$ $\pm 0.1$ $\pm 0.025$ $\pm 0.1$ $\pm 0.05$ $\pm 0.2$	$\pm 2.5$ $\pm 2.5$ $\pm 2.5$ $\pm 5$	nA typ nA max nA typ nA max nA typ nA max	$V_{DD} = 5.5\text{ V}$ $V_D = 4.5/1\text{ V}$ , $V_S = 1/4.5\text{ V}$ ; Test Circuit 2 $V_D = 4.5/1\text{ V}$ , $V_S = 1/4.5\text{ V}$ ; Test Circuit 2 $V_D = V_S = 4.5\text{ V}/1\text{ V}$ ; Test Circuit 3
<b>DIGITAL INPUTS</b> Input High Voltage, $V_{INH}$ Input Low Voltage, $V_{INL}$ Input Current $I_{INL}$ or $I_{INH}$		2.4 0.8  $\pm 0.1$		2.4 0.8  $\pm 0.1$	V min V max  $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{IN} = V_{INL}$ or $V_{INH}$
<b>DYNAMIC CHARACTERISTICS</b> <sup>2</sup> $t_{ON}$ $t_{OFF}$ Break-Before-Make Time Delay, $t_D$ (ADG513 Only) Charge Injection OFF Isolation Channel-to-Channel Crosstalk $C_S$ (OFF) $C_D$ (OFF) $C_D$ , $C_S$ (ON)	250 50 200 16 68 85 9 9 35	500 100	250 50 200 16 68 85 9 9 35	500 100	ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ	$R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_S = 2\text{ V}$ ; Test Circuit 4 $R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_S = 2\text{ V}$ ; Test Circuit 4 $R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ ; $V_{S1} = V_{S2} = 2\text{ V}$ ; Test Circuit 5 $V_S = 0\text{ V}$ , $R_S = 0\ \Omega$ , $C_L = 10\text{ nF}$ ; Test Circuit 6 $R_L = 50\ \Omega$ , $C_L = 5\text{ pF}$ , $f = 1\text{ MHz}$ ; Test Circuit 7 $R_L = 50\ \Omega$ , $C_L = 5\text{ pF}$ , $f = 1\text{ MHz}$ ; Test Circuit 8 $f = 1\text{ MHz}$ $f = 1\text{ MHz}$ $f = 1\text{ MHz}$
<b>POWER REQUIREMENTS</b> $V_{DD}$ $I_{DD}$		4.5/5.5 1		4.5/5.5 1	V min/max $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{DD} = 5.5\text{ V}$ Digital Inputs = 0 V or 5 V

### NOTES

<sup>1</sup>Temperature ranges are as follows: B Versions -40°C to +85°C; T Version -55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# ADG511/ADG512/ADG513—SPECIFICATIONS<sup>1</sup>

Single Supply ( $V_{DD} = 3.3 \text{ V} \pm 10\%$ ,  $V_{SS} = 0 \text{ V}$ ,  $GND = 0 \text{ V}$ , unless otherwise noted)

Parameter	B Version		Unit	Test Conditions/Comments
	25°C	0°C to 70°C		
ANALOG SWITCH Analog Signal Range $R_{ON}$	200	0 V to $V_{DD}$ 500	V $\Omega$ typ $\Omega$ max	$V_D = 1.5 \text{ V}$ , $I_S = -1 \text{ mA}$ ; $V_{DD} = 3 \text{ V}$
LEAKAGE CURRENTS Source OFF Leakage $I_S$ (OFF) Drain OFF Leakage $I_D$ (OFF) Channel ON Leakage $I_D$ , $I_S$ (ON)	$\pm 0.025$ $\pm 0.1$ $\pm 0.025$ $\pm 0.1$ $\pm 0.05$ $\pm 0.2$	$\pm 2.5$ $\pm 2.5$ $\pm 2.5$ $\pm 5$	nA typ nA max nA typ nA max nA typ nA max	$V_{DD} = 3.6 \text{ V}$ $V_D = 2.6/1 \text{ V}$ , $V_S = 1/2.6 \text{ V}$ ; Test Circuit 2 $V_D = 2.6/1 \text{ V}$ , $V_S = 1/2.6 \text{ V}$ ; Test Circuit 2 $V_D = V_S = 2.6 \text{ V}/1 \text{ V}$ ; Test Circuit 3
DIGITAL INPUTS Input High Voltage, $V_{INH}$ Input Low Voltage, $V_{INL}$ Input Current $I_{INL}$ or $I_{INH}$	0.005	2.4 0.8 $\pm 0.1$	V min V max $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{IN} = V_{INL}$ or $V_{INH}$
DYNAMIC CHARACTERISTICS <sup>2</sup> $t_{ON}$ $t_{OFF}$ Break-Before-Make Time Delay, $t_D$ (ADG513 Only) Charge Injection OFF Isolation Channel-to-Channel Crosstalk $C_S$ (OFF) $C_D$ (OFF) $C_D$ , $C_S$ (ON)	600 100 500 11 68 85 9 9 35	1200 160	ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ ; $V_S = 1 \text{ V}$ ; Test Circuit 4 $R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ ; $V_S = 1 \text{ V}$ ; Test Circuit 4 $R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ ; $V_{S1} = V_{S2} = 1 \text{ V}$ ; Test Circuit 5 $V_S = 0 \text{ V}$ , $R_S = 0 \Omega$ , $C_L = 10 \text{ nF}$ ; Test Circuit 6 $R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$ , $f = 1 \text{ MHz}$ ; Test Circuit 7 $R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$ , $f = 1 \text{ MHz}$ ; Test Circuit 8 $f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$
POWER REQUIREMENTS $V_{DD}$ $I_{DD}$	0.0001	3/3.6 1	V min/max $\mu\text{A}$ typ $\mu\text{A}$ max	$V_{DD} = 3.6 \text{ V}$ Digital Inputs = 0 V or 3 V

## NOTES

<sup>1</sup>Temperature range is as follows: B Version  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# ADG511/ADG512/ADG513

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

(T<sub>A</sub> = +25°C unless otherwise noted)

V <sub>DD</sub> to V <sub>SS</sub> .....	44 V
V <sub>DD</sub> to GND .....	-0.3 V to +25 V
V <sub>SS</sub> to GND .....	+0.3 V to -25 V
Analog, Digital Inputs <sup>2</sup> .....	V <sub>SS</sub> - 2 V to V <sub>DD</sub> + 2 V or 30 mA, Whichever Occurs First
Continuous Current, S or D .....	30 mA
Peak Current, S or D .....	100 mA (Pulsed at 1 ms, 10% Duty Cycle max)
<b>Operating Temperature Range</b>	
Industrial (B Version) .....	-40°C to +85°C
Extended (T Version) .....	-55°C to +125°C
Storage Temperature Range .....	-65°C to +150°C
Junction Temperature .....	150°C
Cerdip Package, Power Dissipation .....	900 mW
θ <sub>JA</sub> Thermal Impedance .....	76°C/W
Lead Temperature, Soldering (10 sec) .....	300°C

Plastic Package, Power Dissipation .....	470 mW
θ <sub>JA</sub> Thermal Impedance .....	117°C/W
Lead Temperature, Soldering (10 sec) .....	260°C
SOIC Package, Power Dissipation .....	600 mW
θ <sub>JA</sub> Thermal Impedance .....	77°C/W
Lead Temperature, Soldering	
Vapor Phase (60 sec) .....	215°C
Infrared (15 sec) .....	220°C

### NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG511/ADG512/ADG513 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## ORDERING GUIDE

Model <sup>1</sup>	Temperature Range <sup>2</sup>	Package Option <sup>3</sup>
ADG511BN	-40°C to +85°C	N-16
ADG511BR	-40°C to +85°C	R-16A
ADG511ABR <sup>4</sup>	-40°C to +85°C	R-16A
ADG511TQ <sup>4</sup>	-55°C to +125°C	Q-16
ADG512BN	-40°C to +85°C	N-16
ADG512BR	-40°C to +85°C	R-16A
ADG512ABR <sup>4</sup>	-40°C to +85°C	R-16A
ADG513BN	-40°C to +85°C	N-16
ADG513BR	-40°C to +85°C	R-16A
ADG513ABR <sup>4</sup>	-40°C to +85°C	R-16A

### NOTES

<sup>1</sup>For availability of MIL-STD-883, Class B processed parts, contact factory.

<sup>2</sup>3.3 V specifications apply over 0°C to 70°C temperature range.

<sup>3</sup>N = Plastic DIP; R = 0.15" Small Outline IC (SOIC); Q = Cerdip.

<sup>4</sup>Trench isolated latch-up proof parts. See Trench Isolation section.

# ADG511/ADG512/ADG513

## PIN CONFIGURATION (DIP/SOIC)



Truth Table (ADG511/ADG512)

ADG511 In	ADG512 In	Switch Condition
0	1	ON
1	0	OFF

Truth Table (ADG513)

Logic	Switch 1, 4	Switch 2, 3
0	OFF	ON
1	ON	OFF

## TERMINOLOGY

$V_{DD}$	Most Positive Power Supply Potential.
$V_{SS}$	Most Negative Power Supply Potential in dual supplies. In single supply applications, it may be connected to GND.
GND	Ground (0 V) Reference.
S	Source Terminal. May be an input or output.
D	Drain Terminal. May be an input or output.
IN	Logic Control Input.
$R_{ON}$	Ohmic Resistance between D and S.
$I_S$ (OFF)	Source Leakage Current with the switch "OFF."
$I_D$ (OFF)	Drain Leakage Current with the switch "OFF."
$I_D, I_S$ (ON)	Channel Leakage Current with the switch "ON."
$V_D$ ( $V_S$ )	Analog Voltage on terminals D, S.
$C_S$ (OFF)	"OFF" Switch Source Capacitance.
$C_D$ (OFF)	"OFF" Switch Drain Capacitance.
$C_D, C_S$ (ON)	"ON" Switch Capacitance.
$t_{ON}$	Delay between applying the digital control input and the output switching on.
$t_{OFF}$	Delay between applying the digital control input and the output switching off.
$t_D$	"OFF" or "ON" time measured between the 90% points of both switches when switching from one address state to another.
Crosstalk	A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance.
Off Isolation	A measure of unwanted signal coupling through an "OFF" switch.
Charge Injection	A measure of the glitch impulse transferred from the digital input to the analog output during switching.

# Typical Performance Characteristics—ADG511/ADG512/ADG513



TPC 1. On Resistance as a Function of  $V_D$  ( $V_S$ ) Dual Supplies



TPC 4. Supply Current vs. Input Switching Frequency



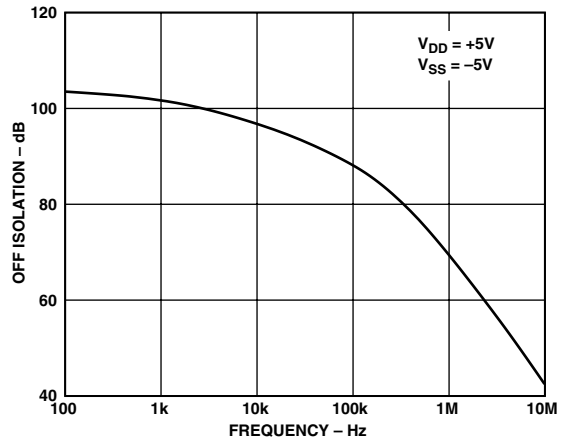
TPC 2. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures



TPC 5. Leakage Currents as a Function of Temperature



TPC 3. On Resistance as a Function of  $V_D$  ( $V_S$ ) Single Supply



TPC 6. Off Isolation vs. Frequency

# ADG511/ADG512/ADG513



TPC 7. Leakage Currents as a Function of  $V_D$  ( $V_S$ )



TPC 8. Crosstalk vs. Frequency

## APPLICATION

Figure 1 illustrates a precise sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an OP07. During the track mode, SW1 is closed and the output  $V_{OUT}$  follows the input signal  $V_{IN}$ . In the hold mode, SW1 is opened and the signal is held by the hold capacitor  $C_H$ .

Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG511/ADG512/ADG513 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a poly-styrene hold capacitor. The droop rate for the circuit shown is typically  $15 \mu\text{V}/\mu\text{s}$ .

A second switch, SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp OP07, which will minimize charge injection effects. Pedestal error is also reduced by the compensation

network  $R_C$  and  $C_C$ . This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the  $\pm 3 \text{ V}$  input range. The acquisition time is  $2.5 \mu\text{s}$  while the settling time is  $1.85 \mu\text{s}$ .



Figure 1. Accurate Sample-and-Hold

## TRENCH ISOLATION

The MOS devices that make up the ADG511A/ADG512A/ADG513A are isolated from each other by an oxide layer (trench) (see Figure 2). When the NMOS and PMOS devices are not electrically isolated from each other, there exists the possibility of “latch-up” caused by parasitic junctions between CMOS transistors. Latch-up is caused when P-N junctions that are normally reverse biased, become forward biased, causing large currents to flow. This can be destructive.

CMOS devices are normally isolated from each other by *junction Isolation*. In Junction Isolation the N and P wells of the CMOS transistors form a diode that is reverse biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A Silicon-Controlled Rectifier (SCR)-type circuit is formed by the two transistors, causing a significant amplification of the current that, in turn, leads to latch-up. With Trench Isolation, this diode is removed; the result is a latch-up-proof circuit.

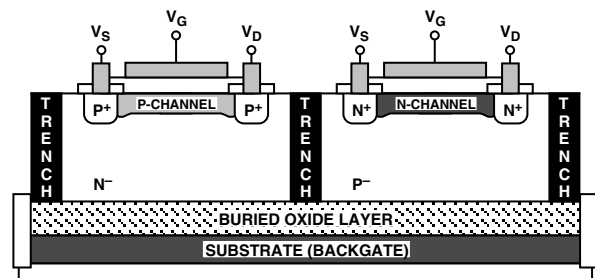


Figure 2. Trench Isolation



## Test Circuits



Test Circuit 1. On Resistance



Test Circuit 2. Off Leakage



Test Circuit 3. On Leakage



Test Circuit 4. Switching Times



Test Circuit 5. Break-Before-Make Time Delay



Test Circuit 6. Charge Injection

# ADG511/ADG512/ADG513



Test Circuit 7. Off Isolation



$$\text{CHANNEL-TO-CHANNEL CROSSTALK} = 20 \times \text{LOG} |V_S/V_{\text{OUT}}|$$

Test Circuit 8. Channel-to-Channel Crosstalk

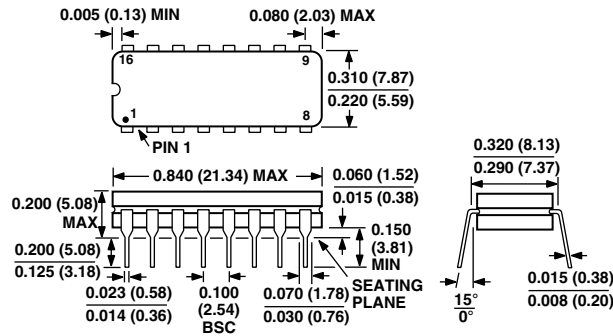
## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

### 16-Lead Plastic DIP (N-16)



### 16-Lead Cerdip (Q-16)



### 16-Lead SOIC (R-16A)



# ADG511/ADG512/ADG513—Revision History

Location	Page
Data Sheet changed from REV. B to REV. C.	
Changes to Specifications table, Dual Supply, and Notes: “T Versions” made singular . . . . .	2
Changes to Specifications table, Single Supply, and Notes: “T Versions” made singular . . . . .	3
Change to Ordering Guide: Removed one line . . . . .	5

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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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